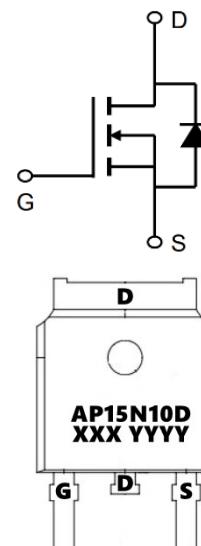


100V N-Channel Enhancement Mode MOSFET
Description

The AP15N10D uses advanced trench technology to provide excellent $R_{DS(ON)}$, low gate charge and operation with gate voltages as low as 4.5V. This device is suitable for use as a Battery protection or in other Switching application.


General Features

$V_{DS} = 100V$ $I_D = 19.3A$

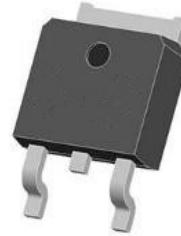
$R_{DS(ON)} < 85m\Omega$ @ $V_{GS}=10V$ (Type: 65m Ω)

Application

Lithium battery protection

Wireless impact

Mobile phone fast charging


Package Marking and Ordering Information

Product ID	Pack	Marking	Qty(PCS)
AP15N10D	TO-252-3L	AP15N10D XXX YYYY	2500

Absolute Maximum Ratings (TC=25°C unless otherwise noted)

Symbol	Parameter	Rating	Units
V _{DS}	Drain-Source Voltage	100	V
V _{GS}	Gate-Source Voltage	± 20	V
I _D @T _c =25°C	Drain Current, V _{GS} @ 10V	19.3	A
I _D @T _c =100°C	Drain Current, V _{GS} @ 10V	10	A
I _{DM}	Pulsed Drain Current ¹	57.9	A
P _D @T _c =25°C	Total Power Dissipation	30	W
P _D @T _A =25°C	Total Power Dissipation ³	2.7	W
EAS	Single Pulse Avalanche Energy ⁴	7	mJ
T _{TG}	Storage Temperature Range	-55 to 150	°C
T _J	Operating Junction Temperature Range	-55 to 150	°C
R _{θJA}	Maximum Thermal Resistance, Junctionambient	55	°C/W
R _{θJC}	Maximum Thermal Resistance, Junction-case	5.1	°C/W



100V N-Channel Enhancement Mode MOSFET
Electrical Characteristics@T_j=25°C(unless otherwise specified)

Symbol	Parameter	Test Condition	Min.	Typ.	Max.	Units
V(BR)DSS	Drain-Source Breakdown Voltage	VGS=0V, ID=250μA	100	107	-	V
IDSS	Zero Gate Voltage Drain Current	VDS=100V, VGS=0V,	-	-	1.0	μA
IGSS	Gate to Body Leakage Current	VDS=0V, VGS=±20V	-	-	±100	nA
VGS(th)	Gate Threshold Voltage	VDS=VGS, ID=250μA	1.2	1.85	2.5	V
RDS(on)	Static Drain-Source on-Resistance note3	VGS=10V, ID=5A	-	65	85	mΩ
		VGS=4.5V, ID=3A	-	75	100	mΩ
g _{fs}	Forward Transconductance	V DS =5V , I D =5A		14		S
RG	Gate Resistance	VDS = 0V, VGS =0V,f =1MHz		3		Ω
C _{iss}	Input Capacitance	VDS=15V, VGS=0V, f=1.0MHz	-	1100	-	pF
C _{oss}	Output Capacitance		-	55	-	pF
C _{rss}	Reverse Transfer Capacitance		-	40	-	pF
Q _g	Total Gate Charge	VDS=50V, ID=5A, VGS=10V	-	11.9	-	nC
Q _{gs}	Gate-Source Charge		-	2.8	-	nC
Q _{gd}	Gate-Drain("Miller") Charge		-	1.7	-	nC
t _{d(on)}	Turn-on Delay Time	VDS=30V, ID=5A, RG=1.8Ω, VGS=10V	-	3.8	-	ns
t _r	Turn-on Rise Time		-	25.8	-	ns
t _{d(off)}	Turn-off Delay Time		-	16	-	ns
t _f	Turn-off Fall Time		-	8.8	-	ns
I _S	Continuous Source Current1,5	VG=VD=0V , Force Current	-	-	14.6	A
I _{SM}	Pulsed Source Current2,5		-	-	25	A
V _{SD}	Diode Forward Voltage2	VGS=0V, IS=10A	-	-	1.2	V

Notes:

- 1、The data tested by surface mounted on a 1 inch 2 FR-4 board with 2OZ copper.
- 2、The data tested by pulsed , pulse width ≤ 300us , duty cycle ≤ 2%
- 3、The EAS data shows Max. rating . The test condition is VDD =80V,VGS =10V,L=0.1mH,I AS =7A
- 4、The power dissipation is limited by 150°C junction temperature
- 5、The data is theoretically the same as I D and I DM , in real applications , should be limited by total power dissipation

Typical Characteristics

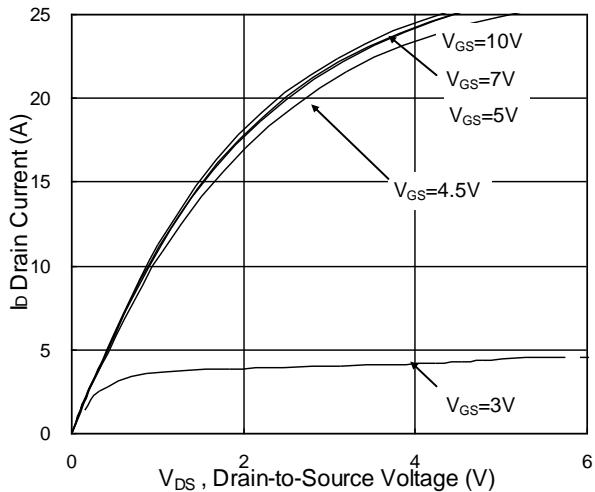


Fig.1 Typical Output Characteristics

100V N-Channel Enhancement Mode MOSFET

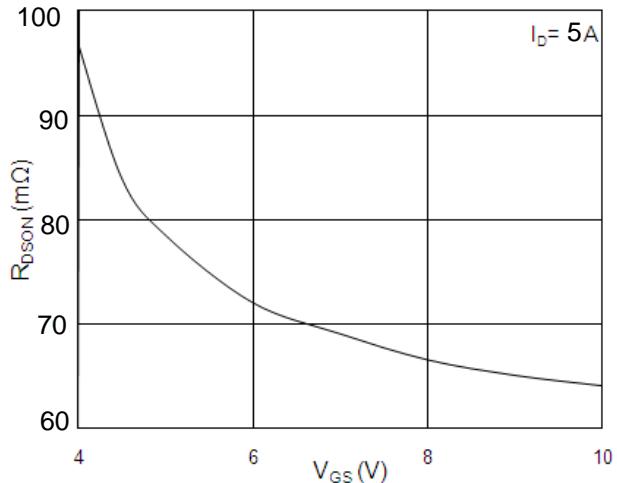


Fig.2 On-Resistance vs. Gate-Source

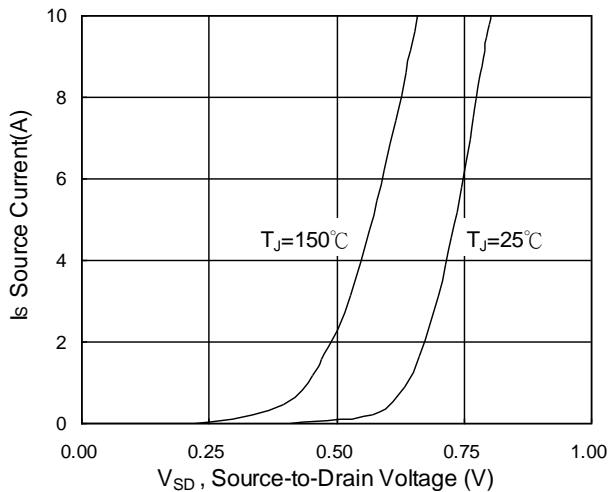


Fig.3 Forward Characteristics Of Reverse

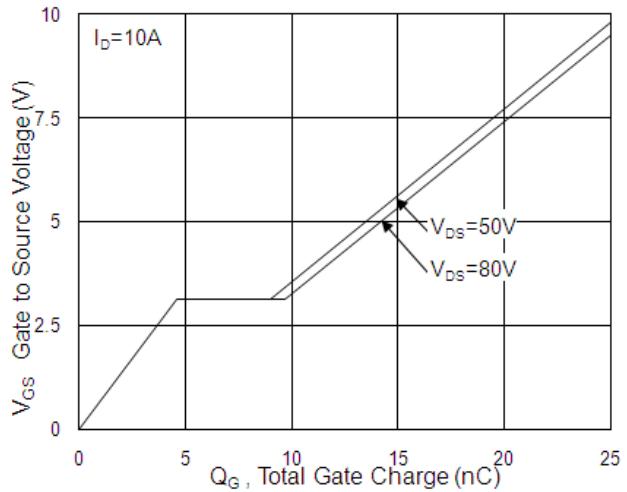


Fig.4 Gate-Charge Characteristics

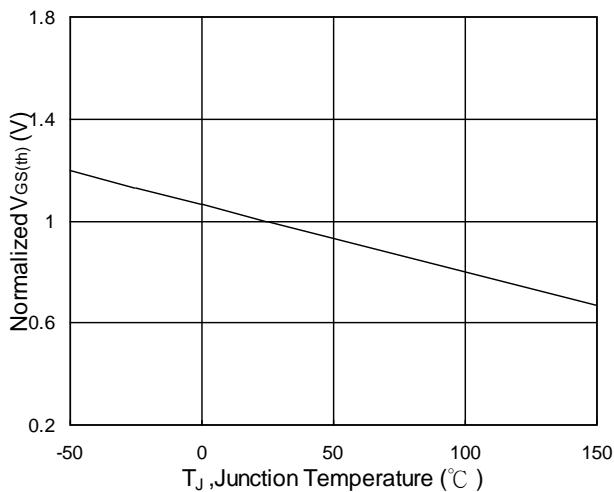


Fig.5 Normalized $V_{GS(th)}$ vs. T_J

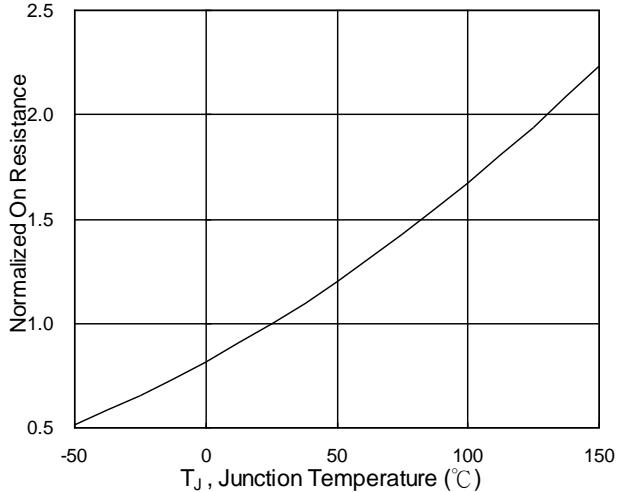
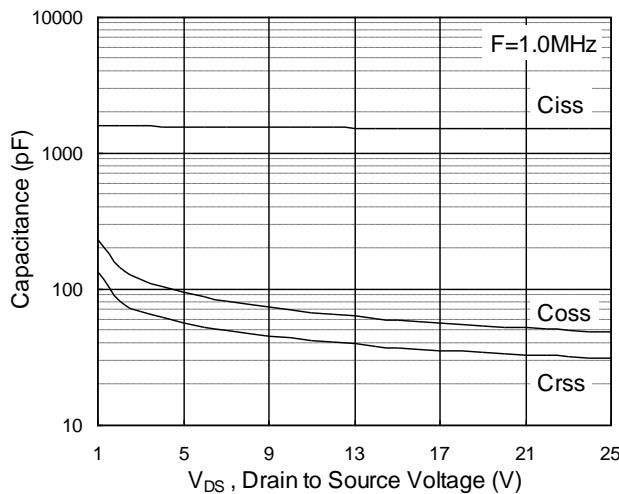
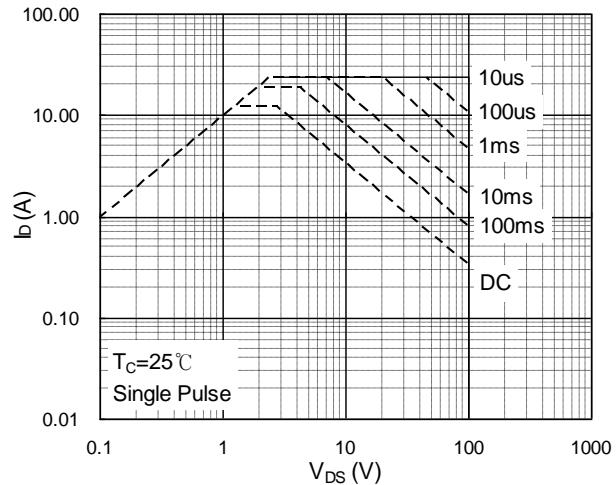
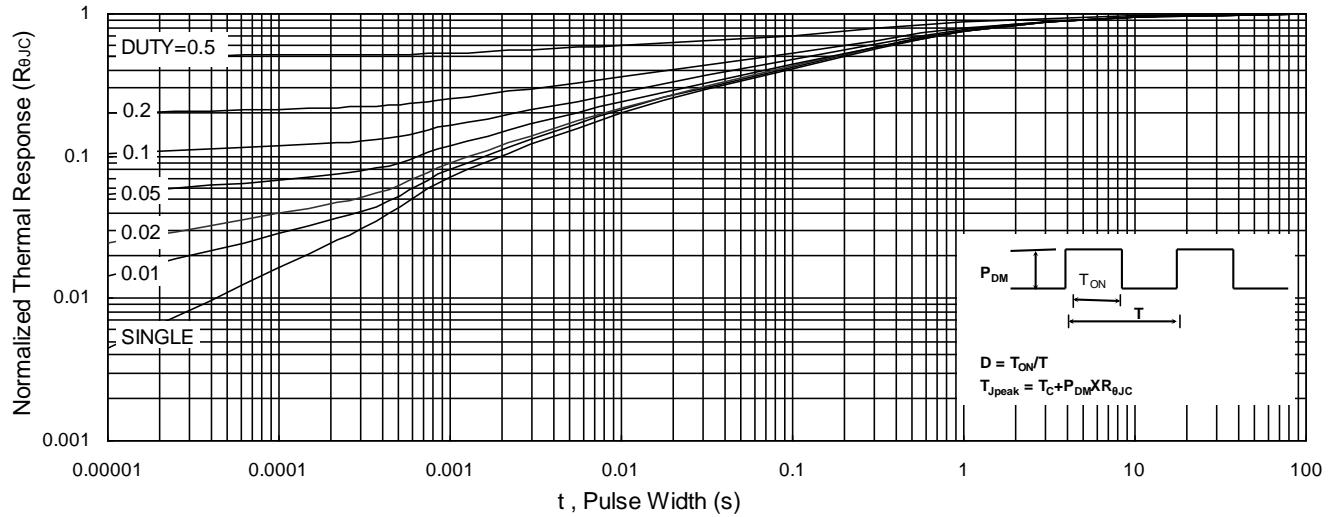
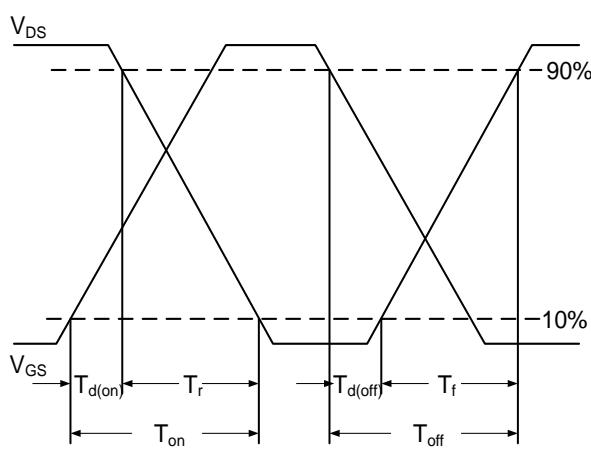
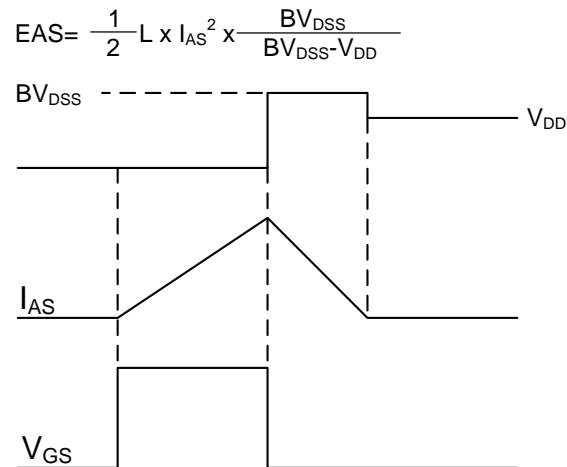
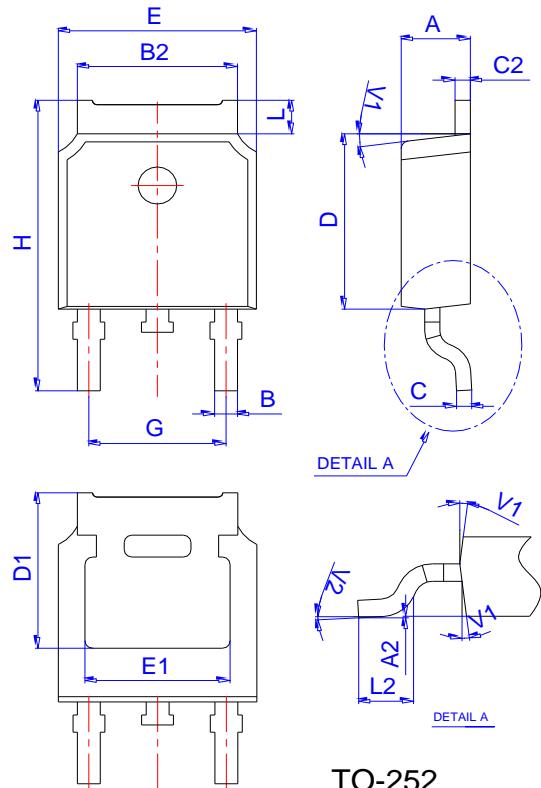


Fig.6 Normalized $R_{DS(on)}$ vs. T_J

100V N-Channel Enhancement Mode MOSFET

Fig.7 Capacitance

Fig.8 Safe Operating Area

Fig.9 Normalized Maximum Transient Thermal Impedance

10 Switching Time Waveform

11 Unclamped Inductive Switching Waveform

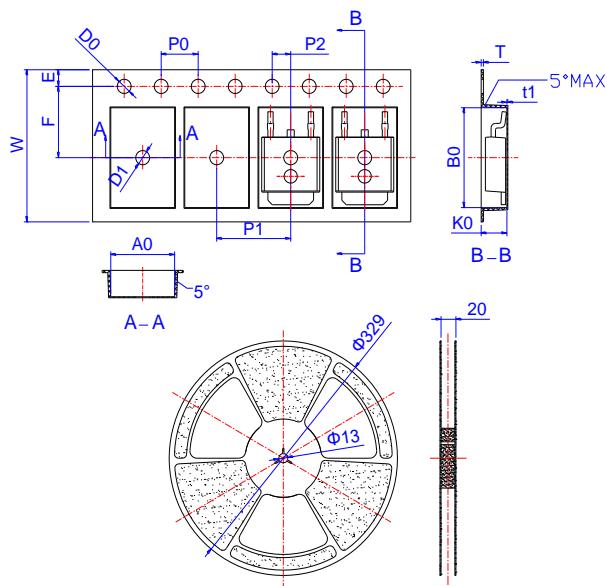
Package Mechanical Data



TO-252

Ref.	Dimensions					
	Millimeters			Inches		
	Min.	Typ.	Max.	Min.	Typ.	Max.
A	2.10		2.50	0.083		0.098
A2	0		0.10	0		0.004
B	0.66		0.86	0.026		0.034
B2	5.18		5.48	0.202		0.216
C	0.40		0.60	0.016		0.024
C2	0.44		0.58	0.017		0.023
D	5.90		6.30	0.232		0.248
D1	5.30REF			0.209REF		
E	6.40		6.80	0.252		0.268
E1	4.63			0.182		
G	4.47		4.67	0.176		0.184
H	9.50		10.70	0.374		0.421
L	1.09		1.21	0.043		0.048
L2	1.35		1.65	0.053		0.065
V1		7°			7°	
V2	0°		6°	0°		6°

Reel Specification-TO-252



Ref.	Dimensions					
	Millimeters			Inches		
	Min.	Typ.	Max.	Min.	Typ.	Max.
W	15.90	16.00	16.10	0.626	0.630	0.634
E	1.65	1.75	1.85	0.065	0.069	0.073
F	7.40	7.50	7.60	0.291	0.295	0.299
D0	1.40	1.50	1.60	0.055	0.059	0.063
D1	1.40	1.50	1.60	0.055	0.059	0.063
P0	3.90	4.00	4.10	0.154	0.157	0.161
P1	7.90	8.00	8.10	0.311	0.315	0.319
P2	1.90	2.00	2.10	0.075	0.079	0.083
A0	6.85	6.90	7.00	0.270	0.271	0.276
B0	10.45	10.50	10.60	0.411	0.413	0.417
K0	2.68	2.78	2.88	0.105	0.109	0.113
T	0.24		0.27	0.009		0.011
t1	0.10		0.004			
10P0	39.80	40.00	40.20	1.567	1.575	1.583